

1. Product profile

1.1 General description

N-channel enhancement mode Field-Effect Transistor (FET) in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

1.2 Features and benefits

- Low R_{DSon}
- Very fast switching
- Trench MOSFET technology

1.3 Applications

- Relay driver
- High-speed line driver
- Low-side loadswitch
- Switching circuits

1.4 Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|-------------------------------|----------------------------------|---|-----|-----|-----|-----|------------------|
| V_{DS} | drain-source voltage | $T_{amb} = 25 \text{ }^{\circ}\text{C}$ | | - | - | 30 | V |
| V_{GS} | gate-source voltage | | | -12 | - | 12 | V |
| I_D | drain current | $V_{GS} = 4.5 \text{ V}; T_{amb} = 25 \text{ }^{\circ}\text{C}; t \leq 5 \text{ s}$ | [1] | - | - | 1.2 | A |
| Static characteristics | | | | | | | |
| R_{DSon} | drain-source on-state resistance | $V_{GS} = 4.5 \text{ V}; I_D = 1.1 \text{ A}; T_j = 25 \text{ }^{\circ}\text{C}$ | | - | 185 | 250 | $\text{m}\Omega$ |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm^2 .

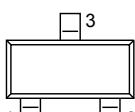
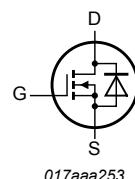
PMV185XN

30 V, single N-channel Trench MOSFET



2. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|--|--|
| 1 | G | gate | | |
| 2 | S | source | | |
| 3 | D | drain |  TO-236AB (SOT23) |  017aaa253 |

3. Ordering information

Table 3. Ordering information

| Type number | Package | | | Version |
|-------------|----------|--|--|---------|
| | Name | Description | | |
| PMV185XN | TO-236AB | plastic surface-mounted package; 3 leads | | SOT23 |

4. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| | [1] |
| PMV185XN | EH% |

[1] % = placeholder for manufacturing site code

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-------------------------|--|-----|------|------|
| V_{DS} | drain-source voltage | $T_{amb} = 25^\circ C$ | - | 30 | V |
| V_{GS} | gate-source voltage | | -12 | 12 | V |
| I_D | drain current | $V_{GS} = 4.5 V; T_{amb} = 25^\circ C; t \leq 5 s$ | [1] | - | A |
| | | $V_{GS} = 4.5 V; T_{amb} = 25^\circ C$ | [1] | - | A |
| | | $V_{GS} = 4.5 V; T_{amb} = 100^\circ C$ | [1] | - | A |
| I_{DM} | peak drain current | $T_{amb} = 25^\circ C$; single pulse; $t_p \leq 10 \mu s$ | - | 4.4 | A |
| P_{tot} | total power dissipation | $T_{amb} = 25^\circ C$ | [2] | - | mW |
| | | | [1] | - | mW |
| | | $T_{sp} = 25^\circ C$ | - | 1275 | mW |

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| Symbol | Parameter | Conditions | | Min | Max | Unit |
|---------------------------|----------------------|--------------------------|-----|-----|-----|------|
| T _j | junction temperature | | | -55 | 150 | °C |
| T _{amb} | ambient temperature | | | -55 | 150 | °C |
| T _{stg} | storage temperature | | | -65 | 150 | °C |
| Source-drain diode | | | | | | |
| I _s | source current | T _{amb} = 25 °C | [1] | - | 0.7 | A |

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm².
[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

6. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|-----------------------|--|----------------------|-----|-----|-----|-----|------|
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | [1] | - | 333 | 385 | K/W |
| | | | [2] | - | 240 | 275 | K/W |
| | | in free air; t ≤ 5 s | [2] | - | 203 | 235 | K/W |
| R _{th(j-sp)} | thermal resistance from junction to solder point | | | - | 85 | 100 | K/W |

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 6 cm².

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| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|--------------------------------|----------------------------------|--|--|-----|------|-----|------|
| I_{GSS} | gate leakage current | $V_{GS} = 12 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$ | | - | - | 100 | nA |
| | | $V_{GS} = -12 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$ | | - | - | 100 | nA |
| R_{DSon} | drain-source on-state resistance | $V_{GS} = 4.5 \text{ V}; I_D = 1.1 \text{ A}; T_j = 25 \text{ }^\circ\text{C}$ | | - | 185 | 250 | mΩ |
| | | $V_{GS} = 4.5 \text{ V}; I_D = 1.1 \text{ A}; T_j = 150 \text{ }^\circ\text{C}$ | | - | 300 | 400 | mΩ |
| | | $V_{GS} = 2.5 \text{ V}; I_D = 0.25 \text{ A}; T_j = 25 \text{ }^\circ\text{C}$ | | - | 255 | 365 | mΩ |
| g_{fs} | forward transconductance | $V_{DS} = 10 \text{ V}; I_D = 1.1 \text{ A}; T_j = 25 \text{ }^\circ\text{C}$ | | - | 2.9 | - | S |
| Dynamic characteristics | | | | | | | |
| $Q_{G(tot)}$ | total gate charge | $V_{DS} = 15 \text{ V}; I_D = 1.1 \text{ A}; V_{GS} = 4.5 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$ | | - | 0.87 | 1.3 | nC |
| Q_{GS} | gate-source charge | | | - | 0.17 | - | nC |
| Q_{GD} | gate-drain charge | | | - | 0.24 | - | nC |
| C_{iss} | input capacitance | $V_{DS} = 15 \text{ V}; f = 1 \text{ MHz}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$ | | - | 76 | - | pF |
| C_{oss} | output capacitance | | | - | 30 | - | pF |
| C_{rss} | reverse transfer capacitance | | | - | 22 | - | pF |
| $t_{d(on)}$ | turn-on delay time | $V_{DS} = 15 \text{ V}; I_D = 1.1 \text{ A}; V_{GS} = 4.5 \text{ V}; R_{G(ext)} = 6 \Omega; T_j = 25 \text{ }^\circ\text{C}$ | | - | 7 | - | ns |
| t_r | rise time | | | - | 11 | - | ns |
| $t_{d(off)}$ | turn-off delay time | | | - | 16 | - | ns |
| t_f | fall time | | | - | 7 | - | ns |
| Source-drain diode | | | | | | | |
| V_{SD} | source-drain voltage | $I_S = 0.7 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$ | | - | 0.8 | 1.2 | V |